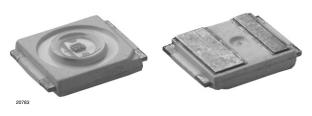
GREEN



Vishay Semiconductors

High Brightness LED Power Module





DESCRIPTION

VLSL30 is a metal core based high brightness LED power module, assembled with 24 HB white LEDs. VLSL30 is a cold white version in a color temperature range of 5000 K to 7000 K. The module is designed for flexible use due to the option for using special reflectors to adjust the emission characteristics.

PRODUCT GROUP AND PACKAGE DATA

Product group: LED
Package: LED module
Product series: power
Angle of half intensity: ± 60°

VLSL30

FEATURES

- Metal core PCB: Cu based
- Single side/single layer PCB
- · Shiny white surface
- 24 LED's minimum 87 lm at 350 mA
- Conductive top layer: Cu
- Isolation layer prepreg type R1566
- ESD withstand voltage: up to 2 kV according to JESD22-A114-B
- Compliant to RoHS directive 2002/95/EC

APPLICATIONS

- Indoor and outdoor applications
- Internal lighting in buildings
- Tunnel lights
- · General lighting application
- Backlighting clusters for advertising boards
- Spotlight illumination for off-road vehicles

Κ

5000 to 7000

PARTS TABLE				
PART	COLOR	LUMINOUS FLUX	COLOR TEMPERATURE	TECHNOLOGY

(at $I_F = 350 \text{ mA typ.}$)

 $\Phi_{V} = 2160 \text{ Im}$

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) VLSL30				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Forward current	Per row	I _F	350	mA
Power dissipation	Total	P _{tot}	33 600	mW
Junction temperature		Tj	120	°C
Operating temperature range		T _{amb}	- 40 to + 85	°C
Storage temperature range		T _{stg}	- 40 to + 85	°C
Decomposition temperature of PCB (for cable assembly)	3 x 10 s	T _D	350	°C

Cold white

InGaN

^{**} Please see document "Vishay Material Category Policy": www.vishay.com/doc?99902

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VLSL30, COLD WHITE PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous flux per row (2)	I _F = 350 mA	Фу	480	540	-	Im
Luminous flux total (2)	$I_{board} = 4 \times 350 \text{ mA}$	ΦV	1920	2160	-	lm
Color temperature	I _F = 350 mA	TK	5000	-	7000	K
Forward voltage per row	$I_F = 350 \text{ mA}$	V _F	18	20	24	V
Class A (V _{Fmax.} - V _{Fmin.}) all rows (3)	I _F = 350 mA	ΔV_{F}	0	-	0.2	V
Class B (V _{Fmax.} - V _{Fmin.}) all rows (3)	I _F = 350 mA	ΔV_{F}	0.2	-	0.4	V
Class C (V _{Fmax.} - V _{Fmin.}) all rows (3)	I _F = 350 mA	ΔV_{F}	0.4	-	0.6	V
Temperature coefficient of V _F per row	I _F = 350 mA	TC _{VF}	-	- 108	-	mV/K
Temperature coefficient of Φ_V	I _F = 350 mA	ТСФ∨	-	- 0.4	-	%/K
Temperature coefficient of color temperature	I _F = 350 mA	TC _{TK}	-	17	-	K/K
Thermal resistance junction-to-board (4)		R _{thJB total}	-	1	-	K/W
Landaria and Landaria		V _{AC}	1000	-	-	V
Isolation voltage		VDC	1500	-	-	V

Notes

SPECIFICATION OF SINGLE LEDS USED FOR THE MODULES

• VLSL30: LED: VLMW711U2U3XV (83229 rev. 1; 02/24/2009)

LUMINOUS FLUX CLASSIFICATION FOR THE SINGLE LED			
GROUP	LUMINOUS FLUX $\Phi_{ m V}$ (Im) CORRELATION TABLE		
STANDARD	MIN.	MAX.	
T3	76.5	87.4	
U2	87.4	99.4	
U3	99.4	113.6	

⁽¹⁾ Forward voltages are tested at a current pulse duration of 1 ms and a tolerance of ± 0.1 V. Luminous flux is measured at a current pulse duration of 25 ms and an accuracy of ± 11 %.

⁽²⁾ Calculated based on single LED unit.

⁽³⁾ V_F classes are marked at the LED cluster and represent the technical classification only. The single groups cannot be specifically ordered.

⁽⁴⁾ Based on theoretical calculation.



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COLOR RANGE AND COLOR BINNING

VLSL30: 5000 K to 7000 K group X to V

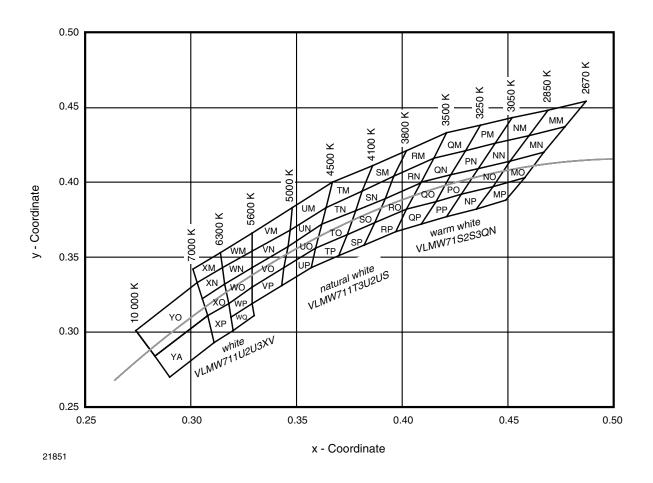
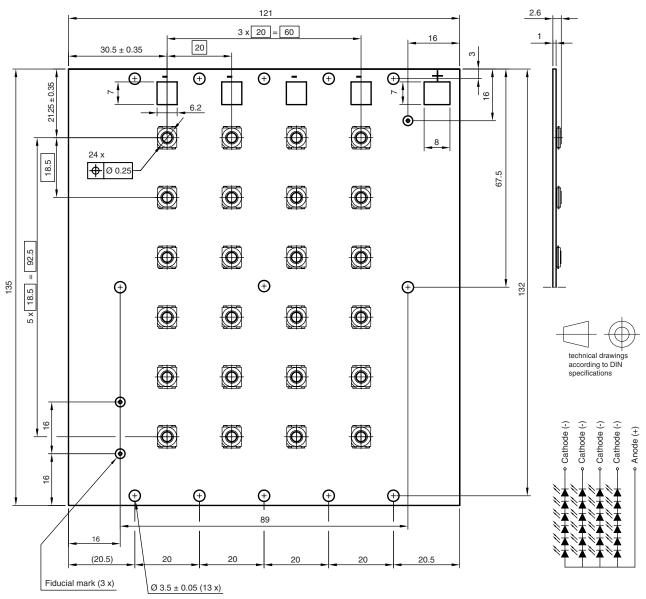


Fig. 1 - Chromaticity Coordinates of Colorgroups

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PCB BASIC DESIGN Dimensions in millimeters



Not indicated tolerances ± 0.15 mm

Drawing-No.: 9.920-6715.01-4 Issue: 1; 28.09.09

1SSUE: 1; 2

2100

Board design with 4 parallel LED rows (4 cathode pads and common anode pad)

PCB CHARACTERISTICS

- Metal core PCB with typical Cu thickness of 800 µm
- ullet Prepreg type R1566 typical 127 μm
- Conductive pattern Cu typical 25 µm
- Total board thickness: 1 mm ± 15 %
- Warpage max. 0.75 % of board dimension

- Solder resist on top side
- Shiny white surface
- Galvanic of solder pads and backside pure matte Sn (\geq 0.8 µm), board edges and hole walls immersion plated
- Assembled with 24 VLMW711xxx LED's. LED position accuracy \pm 0.125 mm from middle axis, horizontal tilt max. 2°



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EMISSION CHARACTERISTIC

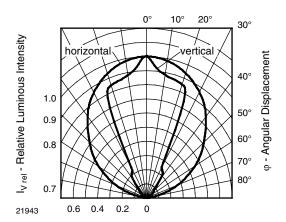


Fig. 2 - Rel. Luminous Intensity vs. Angular Displacement



Fig. 3 - Emission characteristic with reflectors (for info only)

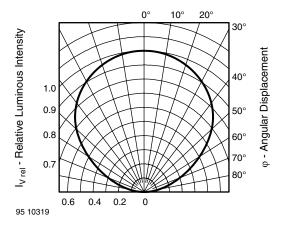
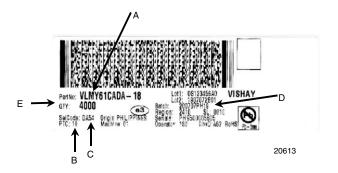


Fig. 4 - Rel. Luminous Intensity vs. Angular Displacement

BAR CODE PRODUCT LABEL



- A. Type of component
- B. Manufacturing plant
- C. SEL selection code (bin): e.g.: $X = \text{code for } V_F \text{ class } (A, B, C)$
- D. Batch:

200707 = year 2007, week 07

PH19 = plant code

E. Total quantity

Note

• 4 PCB's per box, minimum order quantity 24



Vishay

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